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Product Change Notification - JAON-27WIZT300 (Printer Friendly)

Date: 12 Jan 2015

CCB 1444.01 Final Notice: Qualification of palladium coated copper (PdCu) bond wire in selected products of the 90K, 120K, and 121K Notification subject:

technologies available in 8L SOIC package at MMT assembly site.

Notification text: **PCN Status:**

Final notification

Microchip Parts Affected:

See attachments of affected catalog part numbers (CPN) labeled as...

PCN_JAON-27WIZT300_Affected_CPN.xls PCN JAON-27WIZT300 Affected CPN.pdf

Description of Change:

Qualification of palladium coated copper (PdCu) bond wire in selected products of the 90K, 120K, and 121K technologies

available in 8L SOIC package at MMT assembly site.

Impacts to Data Sheet:

None

Reason for Change:

To improve manufacturability by qualifying PdCu wire at MMT assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

February 16, 2015 (date code: 1508)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

August 18, 2014: Issued initial notification.

January 12, 2015: Issued final notification. Attached the qualification report. Revised the estimated first ship date from

November 10, 2014 to February 16, 2015.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the

applicable products.

Attachment(s): PCN_JAON-27WIZT300_Qual_Report.pdf

PCN JAON-27WIZT300 Affected CPN pdf PCN_JAON-27WIZT300_Affected_CPN.xlsx

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